

Press Release

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New dual curing adhesive from Panacol

German adhesive manufacturer Panacol-Elosol GmbH presents its new dual cure epoxy adhesive Vitralit® UD 2018 at this year's Bond Expo in Stuttgart.

Vitralit® UD 2018 is a thixotropic epoxy adhesive with extremely low shrinkage. It can be dispensed very precisely with accurate bead dimensions, making it the perfect choice for micro dispensing in electronic applications, such as fixing SMDs or transceivers on PCBs.

Typically, Vitralit® UD 2018 comes in a pink and fluorescent version. It cures with traditional UV-A discharge lamps or 365 nm LED-light. Any shadowed areas can be post cured thermally.

The adhesive offers all the benefits of epoxy resins: It is highly resistant to environmental stresses, and can better withstand the effects of wide temperature excursions and moisture. This makes Vitralit® UD 2018 the perfect solution for bonding SMDs and electronic components which are frequently subjected to temperature variations and thermal shock.

About Panacol: Panacol-Elosol GmbH is an international supplier in the growth market for industrial adhesives, with an extensive product range that includes UV adhesives, structural adhesives, and silicones. Headquartered in Steinbach Germany, Panacol-Elosol GmbH is a member of UV equipment manufacturer Hönle Group.

Visit us at BondExpo 2015 in Stuttgart in hall 9, stand 9410!